

MiniSKiiP®1

3-phase bridge rectifier +
brake chopper + 3-phase
bridge inverter
SKiiP 12NAB066V1

Features

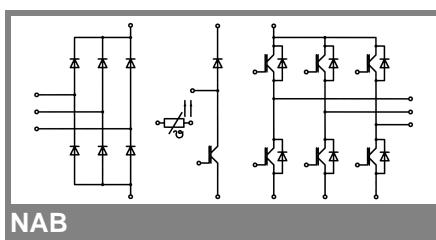
- Trench IGBTs
- Robust and soft freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognised file no. E63532

Typical Applications

- Inverter up to 5 kVA
- Typical motor power 2,2 kW

Remarks

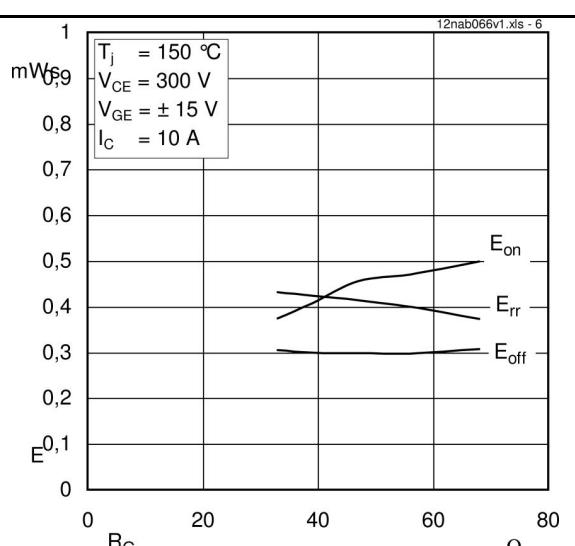
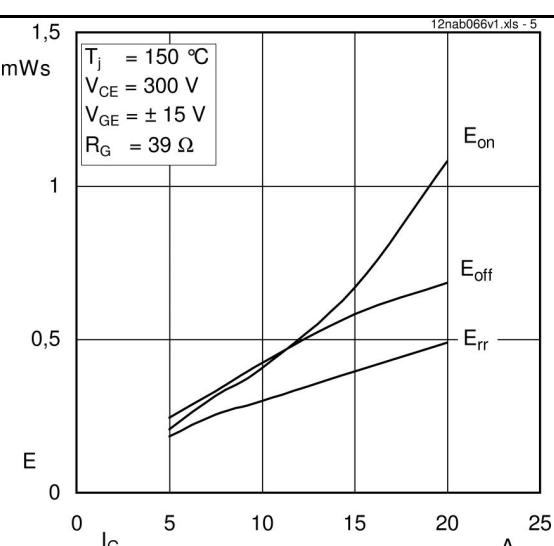
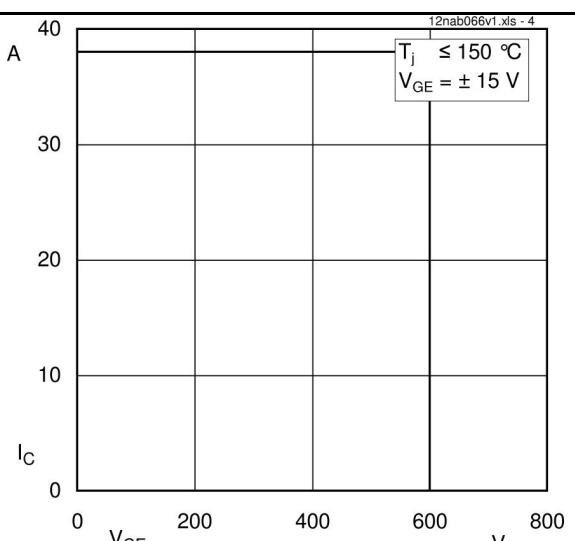
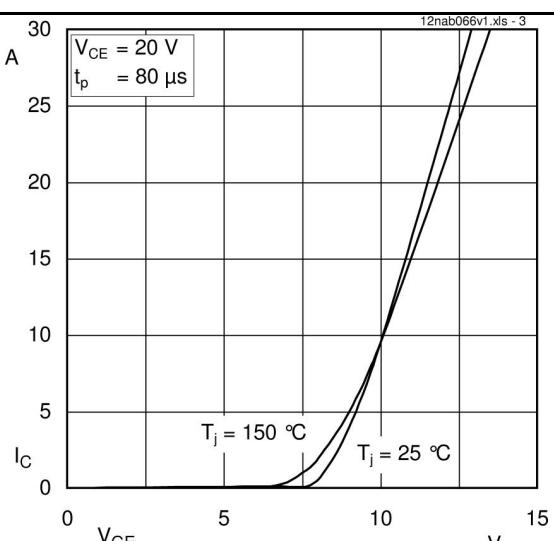
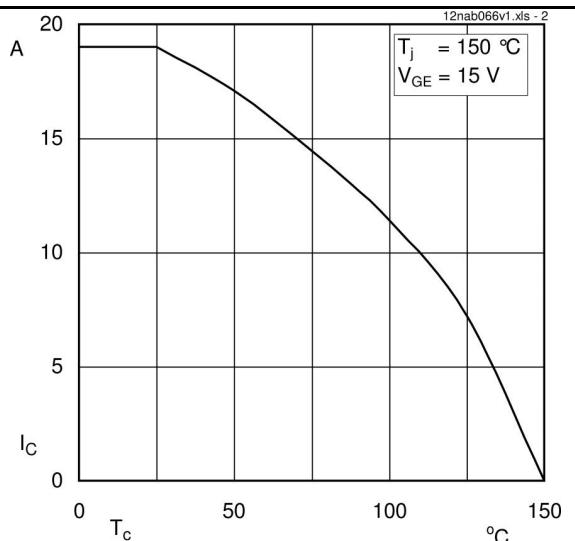
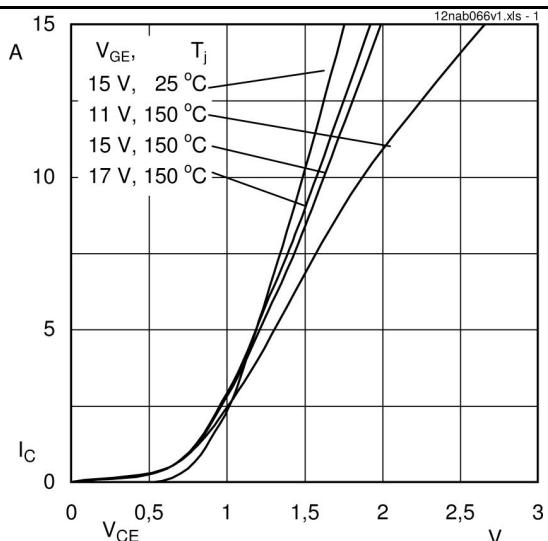
- Case temperature limited to $T_C = 125^\circ\text{C}$ max.
- Product reliability results are valid for $T_j = 150^\circ\text{C}$
- SC data: $t_p \leq 6 \mu\text{s}$; $V_{GE} \leq 15 \text{ V}$; $T_j = 150^\circ\text{C}$; $V_{CC} = 360 \text{ V}$
- V_{CEsat} , V_F = chip level values



Absolute Maximum Ratings		$T_S = 25^\circ\text{C}$, unless otherwise specified		
Symbol	Conditions	Values		Units
IGBT - Inverter, Chopper				
V_{CES}		600		V
I_C	$T_s = 25 (70)^\circ\text{C}, T_j = 150^\circ\text{C}$	19 (14)	A	
I_C	$T_s = 25 (70)^\circ\text{C}, T_j = 175^\circ\text{C}$	20 (16)	A	
I_{CRM}	$t_p = 1 \text{ ms}$	20	A	
V_{GES}		± 20	V	
Diode - Inverter, Chopper				
I_F	$T_s = 25 (70)^\circ\text{C}, T_j = 150^\circ\text{C}$	20 (15)	A	
I_F	$T_s = 25 (70)^\circ\text{C}, T_j = 175^\circ\text{C}$	20 (18)	A	
I_{FRM}	$t_p = 1 \text{ ms}$	20	A	
Diode - Rectifier				
V_{RRM}		800	V	
I_F	$T_s = 70^\circ\text{C}$	35	A	
I_{FSM}	$t_p = 10 \text{ ms}, \sin 180^\circ, T_j = 25^\circ\text{C}$	220	A	
$i_{\dot{t}}$	$t_p = 10 \text{ ms}, \sin 180^\circ, T_j = 25^\circ\text{C}$	240	A^2s	
I_{RMS}	per power terminal (20 A / spring)	20	A	
T_j	IGBT, Diode	-40...+175	$^\circ\text{C}$	
T_{stg}		-40...+125	$^\circ\text{C}$	
V_{isol}	AC, 1 min.	2500	V	

Characteristics		$T_S = 25^\circ\text{C}$, unless otherwise specified		
Symbol	Conditions	min.	typ.	max.
IGBT - Inverter, Chopper				
$V_{CE(sat)}$	$I_{Cnom} = 10 \text{ A}, T_j = 25 (150)^\circ\text{C}$	1,1	1,45 (1,65)	1,85 (2,05)
$V_{GE(th)}$	$V_{CE} = V_{GE}, I_C = 1 \text{ mA}$		5,8	V
$V_{CE(TO)}$	$T_j = 25 (150)^\circ\text{C}$		0,9 (0,7)	1,1 (1)
r_{CE}	$T_j = 25 (150)^\circ\text{C}$		60 (100)	$\text{m}\Omega$
C_{ies}	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$		0,58	nF
C_{oes}	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$		0,12	nF
C_{res}	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$		0,04	nF
$R_{CC+EE'}$	spring contact-chip $T_s = 25 (150)^\circ\text{C}$			$\text{m}\Omega$
$R_{th(j-s)}$	per IGBT		2	K/W
$t_{d(on)}$	under following conditions		25	ns
t_r	$V_{CC} = 300 \text{ V}, V_{GE} = \pm 15 \text{ V}$		25	ns
$t_{d(off)}$	$I_{Cnom} = 10 \text{ A}, T_j = 150^\circ\text{C}$		190	ns
t_f	$R_{Gon} = R_{Goff} = 39 \Omega$		40	ns
$E_{on} (E_{off})$	inductive load		0,5 (0,3)	mJ
Diode - Inverter, Chopper				
$V_F = V_{EC}$	$I_F = 10 \text{ A}, T_j = 25 (150)^\circ\text{C}$		1,3 (1,3)	1,6 (1,6)
$V_{(TO)}$	$T_j = 25 (150)^\circ\text{C}$		0,9 (0,8)	1 (0,9)
r_T	$T_j = 25 (150)^\circ\text{C}$		40 (50)	$\text{m}\Omega$
$R_{th(j-s)}$	per diode		2,5	K/W
I_{RRM}	under following conditions		15,8	A
Q_{rr}	$I_{Fnom} = 10 \text{ A}, V_R = 300 \text{ V}$		1,5	μC
E_{rr}	$V_{GE} = 0 \text{ V}, T_j = 150^\circ\text{C}$		0,5	mJ
	$di_F/dt = 810 \text{ A}/\mu\text{s}$			
Diode - Rectifier				
V_F	$I_{Fnom} = 15 \text{ A}, T_j = 25^\circ\text{C}$		1,1	V
$V_{(TO)}$	$T_j = 150^\circ\text{C}$		0,8	V
r_T	$T_j = 150^\circ\text{C}$		20	$\text{m}\Omega$
$R_{th(j-s)}$	per diode		1,5	K/W
Temperature Sensor				
R_{ts}	$3\%, T_r = 25 (100)^\circ\text{C}$		1000(1670)	Ω
Mechanical Data				
w		35	g	
M_s	Mounting torque	2	2,5	Nm

SKiiP 12NAB066V1 CONVERTER, INVERTER, BRAKE



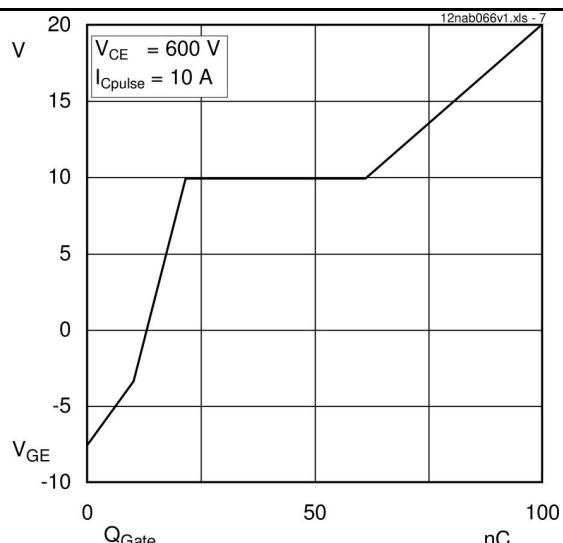


Fig. 7 Typ. gate charge characteristic

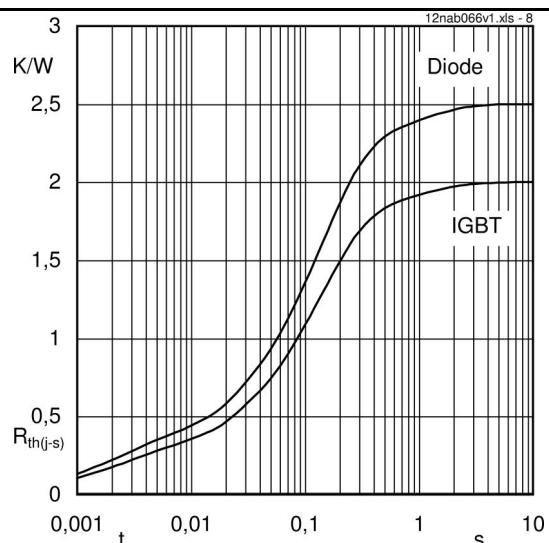


Fig. 8 Typ. thermal impedance

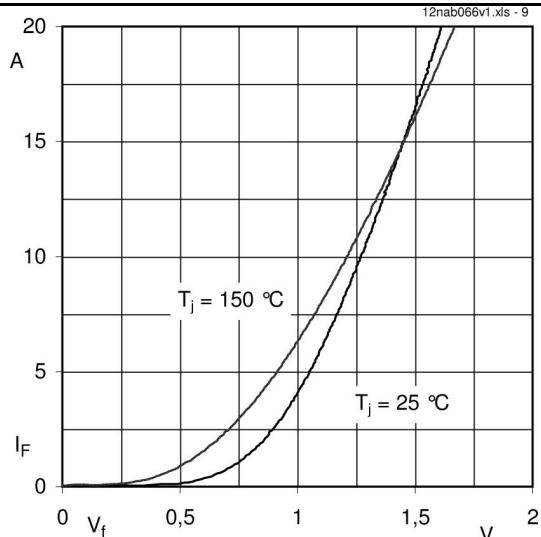


Fig. 9 Typ. freewheeling diode forward characteristic

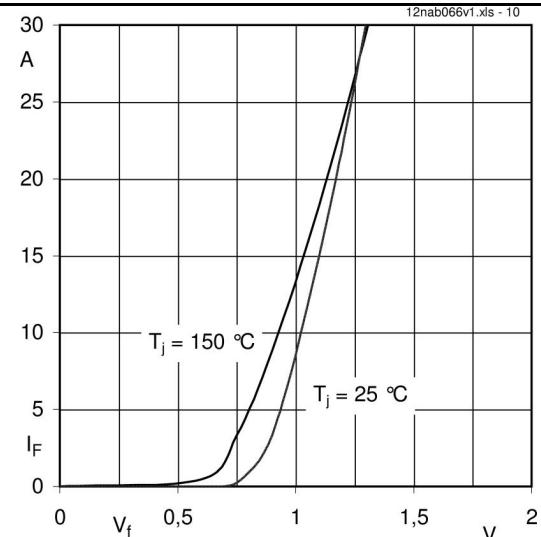
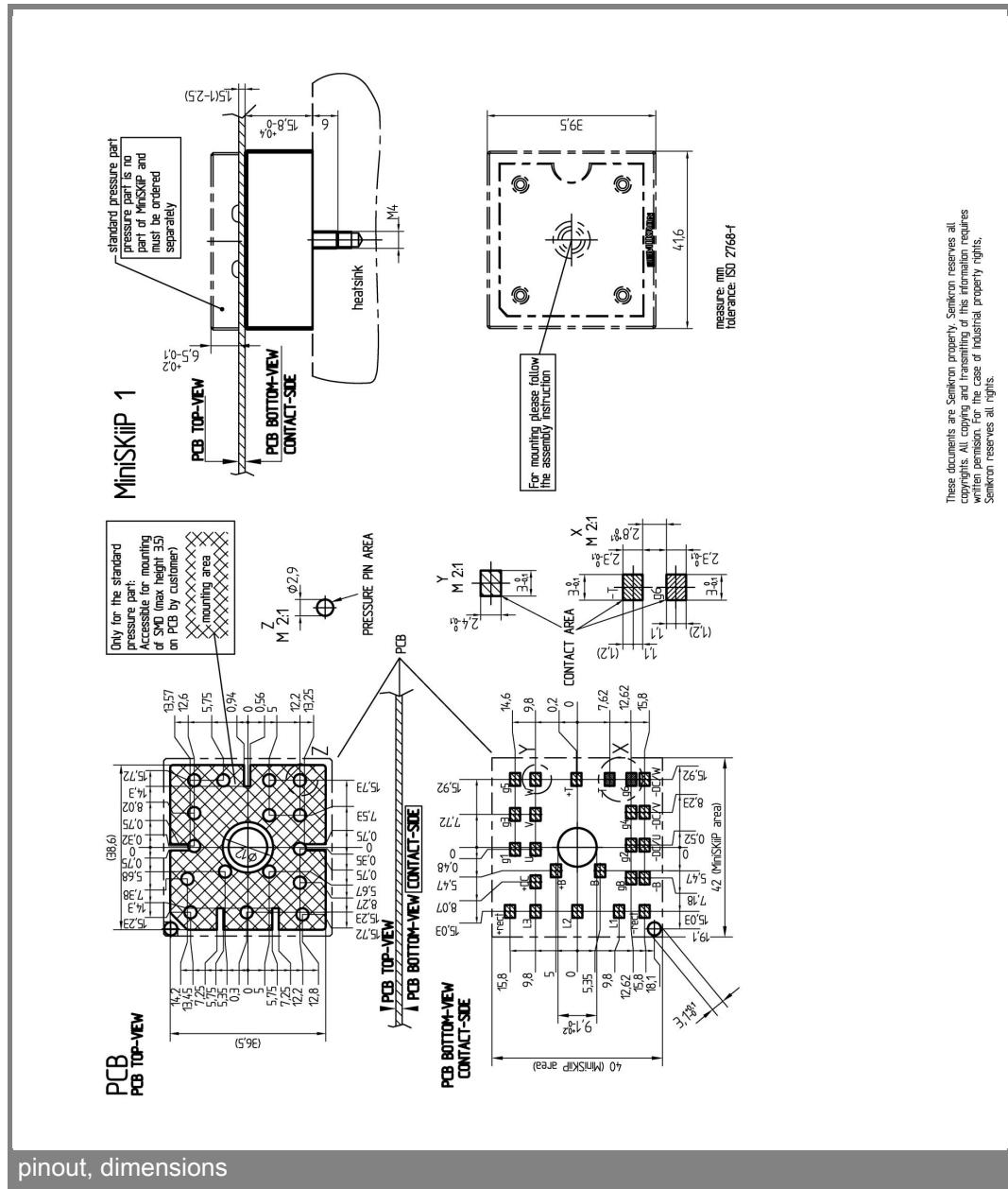
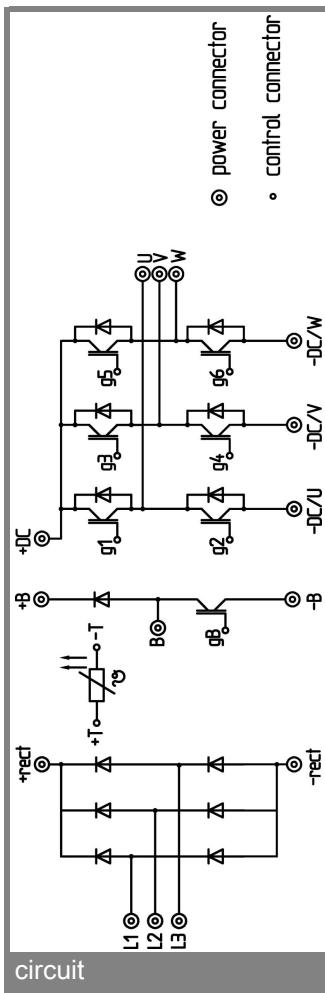


Fig. 10 Typ. input bridge forward characteristic



This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

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